

#### **Features**

- PLCC SMD LED
- Close responsively to the human eye spectrum
- Light to Current, analog output
- Good output linearity across wide illumination range
- Low sensitivity variation across various light sources

### **Applications**

- Infrared application system
- Optoelectronic automatic control system
- Optoelectronic switch
- Printer
- Counters and sorters
- Encoders
- Floppy disk drive
- Video camera, tape and card readers
- Position sensors

### **Description**

The IN-P4634ATHIRPT is a popular package with versatile design capabilities. It is a PLCC type LED which can be used in various applications. the device is matched to visible light and infrared radiation.

### **Recommended Solder Pattern**

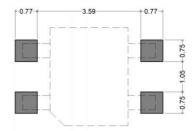
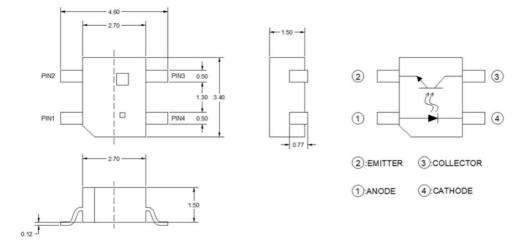


Figure 1. IN-P4634ATHIRPT Solder Pattern

# Package Dimensions in mm



#### Notes.

- All dimensions are in millimeters.
- Tolerance is ± 0.10 mm unless otherwise noted

Figure 2. IN-P4634ATHIRPT Package Dimensions



# **Absolute Maximum Rating at 25°C**

Symbol	Parameters	Ratings	Units	Notes			
	INPUT (Emitter)						
VR	Reverse Voltage	5	V				
lF	Forward Voltage	50	mA				
IFp	Peak Forward Voltage	1	А	1			
Pd	Total Power Dissipation	75	mW				
	OUTPUT (Detector)						
BVCEO	Collector-Emitter Breakdown Voltage	30	V	2			
BVECO	Emitter-Collector Breakdown Voltage	5	V	3			
lc	Collector Current	20	mA				
Pd	Total Power Dissipation	75	mW				
Topr	Operating Temperature		°C				
Tstg	Storage Temperature	-40~+100	°C				
Tsol	Soldering Temperature	260	°C	4			

#### **Notes**

- 1. IFP Conditions--Pulse Width ≤ 100µs and Duty ≤ 1%.
- 2. Test conditions: Ic=100µA, Ee=0mW/cm2.
- 3. Test conditions: IE=100µA, Ee=0mW/cm2.
- 4. Soldering time ≤ 5 seconds.

#### **ESD Precaution**

ATTENTION: Electrostatic Discharge (ESD) protection



The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).



# **Electro-Optical Characteristics**

Symbol	Parameters	Test conditions	Min	Тур	Max	Units	Notes			
	INPUT (Emitter)									
VF	Forward Voltage	IF=20mA	-	1.2	1.6	V				
λ <sub>P</sub>	Peak Wavelength	IF=20mA	-	940	-	nm				
lR	Reverse Voltage	VR=5V	-	-	10	uA				
	OUTPUT (Detector)									
VCE(sat)	Collector-Emitter Saturation Voltage	Ic=2mA Ee=1mW/cm2	-	-	0.4	V				
ICEO	Collector Dark Current	VCE=10V Ee=0mW/cm2	-	-	100	nA				
IC(ON)	On State Collector Current	V <sub>CE</sub> =5V IF=10mA d=1mm	0.18	-	0.40	mA	5			
ILEAK	Leakage Current	V <sub>CE</sub> =5V IF=10mA With no reflection	-	-	1	uA				
tr	Rise Time	V <sub>CE</sub> =2V, I <sub>C</sub> =100uA	-	20	-	uS	6			
tf	Fall Time	RL=1KΩ d=1mm	-	20	-	uS	6			

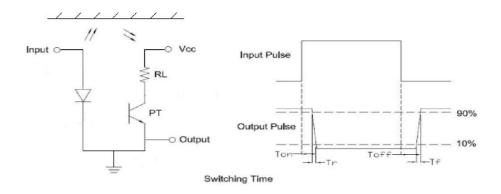
### **Notes**

5. Ic Bin Rank (mA):

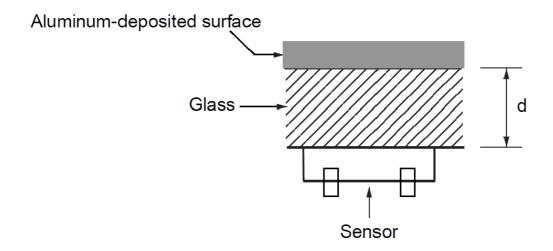
Bin Code	BX3	BX4	BX5	BX6	BX7
Min	0.18	0.23	0.28	0.33	0.38
Max	0.23	0.28	0.33	0.38	0.40



### 6. Test circuit:

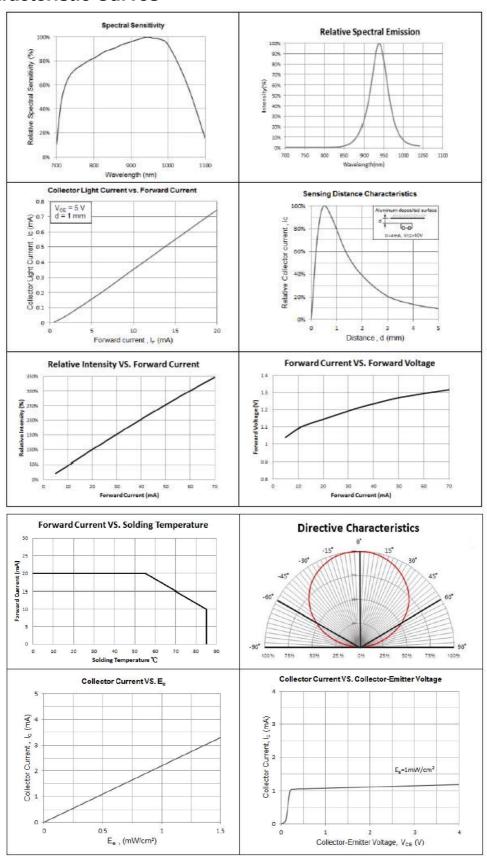


# Light Current Measurement Setup Diagram:





### **Typical Characteristic Curves**

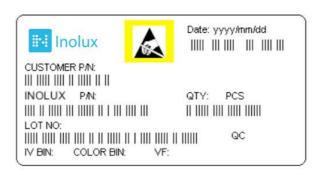




# **Ordering Information**

Product	Symbol	Parameters	Test conditions	Min	Тур	Max	Units	Orderable Part Number
IN- P4634ATHIRPT	IC(ON)	On State Collector Current	V <sub>CE</sub> =5V IF=10mA d=1mm	0.18	0.28	0.40	mA	IN- P4634ATHIRPT

## **Label Specifications**



### Inolux P/N:

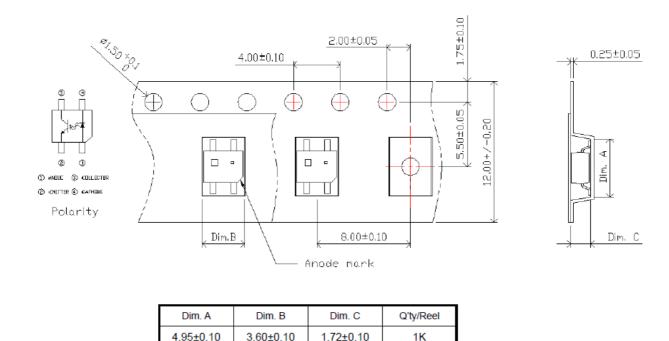
ı	Ν	-	Р	4634	Α	Т	HIR	PT	-	-	-	-	-
			Material	Package	Variation	Orientation	Lens	Color			iston tamp		
Ino SM	lux 1D		PLCC - P	4634 4.6x3.4x		T = Top Mount	HIR =940nm	PT = Photo Transistor					

#### Lot No.:

Z	2	0	1	7	01	24	001
Internal		Voor (2017	2019 \	Month	Data	Corial	
Tracker		Year (2017	, 2016,)	IVIOTILIT	Date	Serial	

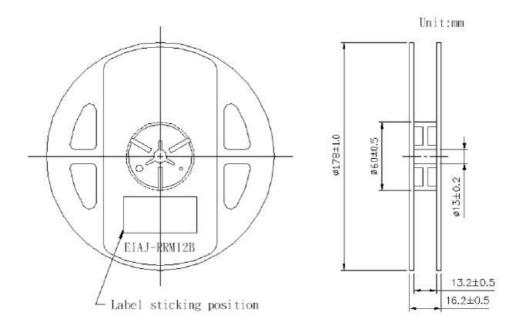


# **Packaging Information:**



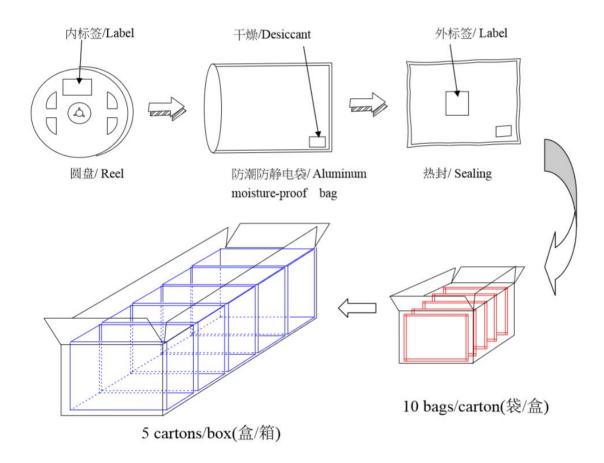
Unit: mm

### **Reel Dimension**





### **Packing Dimension**



5 boxes per carton are available depending on shipment quantity.

	Specification	Material	Quantity
Carrier tape	Per EIA 481-1A specs	Conductive black tape	1000pcs per reel
Reel	Per EIA 481-1A specs	Conductive black	
Label	IN standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	IN standard	Paper	Non-specified
Otherus	·		·

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

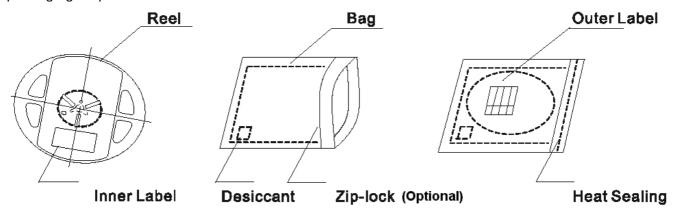


## **Dry Pack**

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

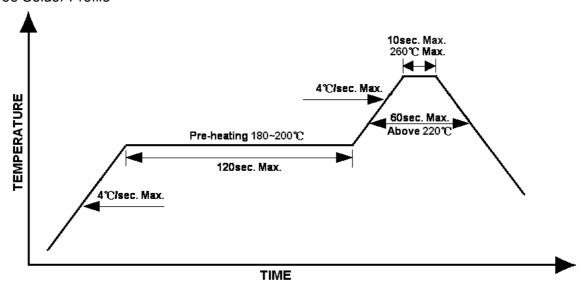
The packaging sequence is as follows:



### **Reflow Soldering**

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):







#### **Precautions**

- Avoid exposure to moisture at all times during transportation or storage.
- Anti-Static precaution must be taken when handling GaN, InGaN, and AllnGaP products.
- It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage.
- Avoid operation beyond the limits as specified by the absolute maximum ratings.
- Avoid direct contact with the surface through which the LED emits light.
- If possible, assemble the unit in a clean room or dust-free environment.

### Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

### Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min</li>
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

### **Cautions of Pick and Place**

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electro-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.





Reliability

ilability			
Item	Frequency/ lots/ samples/ failures	Standards	Conditions
Dunnandition	For all reliability	Reference J-STD-020	1.) Baking at 85°C for 24hrs
Precondition	monitoring tests according to JEDEC Level 2		2.) Moisture storage at 85°C/ 60% R.H. for 168hrs
Solderability	1Q/ 1/ 22/ 0	JESD22-B102-B And CNS-5068	Accelerated aging 155°C/ 24hrs Tinning speed: 2.5+0.5cm/s Tinning: A: 215°C/ 3+1s or B: 260°C/ 10+1s
Resistance to soldering heat		CNS-5067	Dipping soldering terminal only Soldering bath temperature A: 260+/-5°C; 10+/-1s B: 350+/-10°C; 3+/-0.5s
Operating life test	1Q/ 1/ 40/ 0	CNS-11829	1.) Precondition: 85°C baking for 24hrs 85°C/ 60%R.H. for 168hrs 2.) Tamb25°C; IF=20mA; duration 1000hrs
High humidity, high temperature bias	1Q/ 1/ 45/ 0	JESD-A101-B	Tamb: 85°C Humidity: 85% R.H., IF=5mA Duration: 1000hrs
High temperature bias	1Q/ 1/ 20	IN specs.	Tamb: 55°C IF=20mA Duration: 1000hrs
Pulse life test	1Q/ 1/ 40/ 0		Tamb25°C, If=20mA,, Ip=100mA, Duty cycle=0.125 (tp=125 $\mu$ s,T=1sec) Duration 500hrs)
Temperature cycle	1Q/ 1/ 76/ 0	JESD-A104-A IEC 68-2-14, Nb	A cycle: -40 degree C 15min; +85 degree C 15min Thermal steady within 5 min 300 cycles 2 chamber/ Air-to-air type
High humidity storage test	1Q/ 1/ 40/ 0	CNS-6117	60+3°C 90+5/-10% R.H. for 500hrs
High temperature storage test	1Q/ 1/ 40/ 0	CNS-554	100+10°C for 500hrs
Low temperature storage test	1Q/ 1/ 40/ 0	CNS-6118	-40+5°C for 500hrs





**Revision History** 

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	06-12-2021

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